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2-902

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of:

William H. Lange, et al.

Title: METHOD OF FORMING A PTFE
INSULATION LAYER OVER A METALLIC
CONDUCTOR AND PRODUCT DERIVED
THEREFROM

Serial No.: New Application

Filed: November 21, 2001

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) Group Art Unit: Not Assigned
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) Examiner: Not Assigned
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) (Our Docket No. 3965-28)
)
)

Hartford, Connecticut, November 21, 2001

Box PATENT APPLICATION
U.S. Patent & Trademark Office
P.O. Box 2327
Arlington, VA 22202

INFORMATION DISCLOSURE STATEMENT

S I R:

Attached hereto is Form PTO-1449 listing documents believed relevant
to the subject application. It is respectfully requested that the Examiner consider
these documents and an initialed copy of the form be returned to the undersigned.

This disclosure statement should not be construed as a representation
that a search has been made or that no other material information as defined in 37

C.F.R. § 1.56 (a) exists. In addition, the cited documents are not necessarily analogous art.

It is believed that this disclosure complies with the requirements of 37 C.F.R. § 1.56, 1.97, and 1.98 and the Manual of Patent Examining Procedures § 609. If for some reason, the Examiner considers otherwise, it is respectfully requested that the Applicants' representative be called so that any deficiencies can be remedied.

Since no action on the merits has issued in this application, Applicants believe no fee is due for filing this Information Disclosure Statement. If it is determined that a fee is required, please charge deposit account no. 13-0235.

Respectfully submitted,

By *Daniel G. Mackas*
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FORM PTO-1449

INFORMATION DISCLOSURE STATEMENT BY APPLICANT(S)

Docket No.: 3965-28

U.S. Serial No.: New Application

Applicant: William H. Lange, et al.

U.S. Filing Date: November 21, 2001

Title: Method of Forming a PTFE

Group Art Unit: Not Assigned

Insulation Layer Over a Metallic Conductor
and Product Derived TherefromU.S. PATENT DOCUMENTS

<u>Examiner's Initials</u>	<u>Patent Number</u>	<u>Patent Date</u>	<u>Name</u>	<u>Class Subclass</u>
	6,231,919 B1	5/15/01	Craton	427/119
	6,139,957	10/31/00	Craton	428/379
	6,103,031	8/15/00	Aeschbacher	156/54
	6,064,008	5/16/00	Craton	174/110 FC
	5,922,155	7/13/99	Clouet	156/51
	5,904,978	5/18/99	Hanrahan	428/313.5
	5,814,406	9/29/98	Newmoyer	428/379
	5,770,819	6/23/98	Mehan	174/110 PM
	5,750,931	5/12/98	McGregor	174/110 PM
	5,614,319	3/25/97	Wessels	428/379
	5,576,515	11/19/96	Bleich	174/110 PM
	5,554,236	9/10/96	Singles	156/52
	5,527,612	6/18/96	Ohta	428/379
	5,477,011	12/19/95	Singles	174/102 R
	5,426,264	6/20/95	Livingston	174/102 R
	5,397,855	3/14/95	Ferlier	174/36
	5,393,929	2/28/95	Yagihashi	174/36
	5,281,766	1/25/94	Hildreth	174/120 R
	5,227,103	7/13/93	Muschiatti	264/45.9
	5,210,377	5/11/93	Kennedy	174/107
	5,110,998	5/5/92	Muschiatti	174/24
	5,059,263	10/22/91	Sahakian	156/56
	4,801,501	1/31/89	Harlow	428/383
	4,304,713	12/8/81	Perelman	264/45.9
	4,273,829	6/16/81	Perreault	428/383
	3,616,177	10/26/71	Gumerman	161/165

FOREIGN PATENT DOCUMENTS

<u>Examiner's Initials</u>	<u>Document Number</u>	<u>Date</u>	<u>Country</u>	<u>Translation</u> <u>Yes</u> <u>No</u>

OTHER DOCUMENTS

Examiner's
Initials

EXAMINER

DATE CONSIDERED

EXAMINER:

Initial if citation considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).